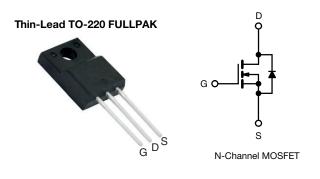
Vishay Siliconix



E Series Power MOSFET



PRODUCT SUMMARY					
V _{DS} (V) at T _J max.	550				
R _{DS(on)} max. (Ω) at 25 °C	V _{GS} = 10 V 0.243				
Q _g max. (nC)	66				
Q _{gs} (nC)	8				
Q _{gd} (nC)	14				
Configuration	Single				

FEATURES

- Low figure-of-merit (FOM) Ron x Qg
- Low input capacitance (Ciss)
- Reduced switching and conduction losses
- Low gate charge (Q_q)
- Avalanche energy rated (UIS)
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

APPLICATIONS

- Computing
 - PC silver box / ATX power supplies
- Lighting
 - Two stage LED lighting
- Consumer electronics
- · Applications using hard switched topologies
 - Power factor correction (PFC)
 - Two switch forward converter
 - Flyback converter
- Switch mode power supplies (SMPS)

ORDERING INFORMATION	
Package	Thin-Lead TO-220 FULLPAK
Lead (Pb)-free	SiHA15N50E-E3
Lead (Pb)-free and halogen-free	SiHA15N50E-GE3

ABSOLUTE MAXIMUM RATINGS (T _C	= 25 °C, un	less otherwis	se noted)		
PARAMETER			SYMBOL	LIMIT	UNIT
Drain-source voltage			V _{DS}	500	v
Gate-source voltage			V _{GS}	± 30	v
Continuous drain current ($T_{,1} = 150 \text{ °C}$) ^e	V at 10 V	T _C = 25 °C T _C = 100 °C	- I _D -	14.5	
Continuous drain current $(1_j = 150 \text{ C})^2$	V _{GS} at 10 V	T _C = 100 °C		9.2	А
Pulsed drain current ^a			I _{DM}	28	
Linear derating factor				1.25	W/°C
Single pulse avalanche energy ^b			E _{AS}	136	mJ
Maximum power dissipation			PD	33	W
Operating junction and storage temperature range			T _J , T _{stg}	-55 to +150	°C
Drain-source voltage slope	$V_{DS} = 0 V \text{ to } 80 \% V_{DS}$		dV/dt	70	V/ns
Reverse diode dV/dt ^d			av/at	27	v/ns
Soldering recommendations (peak temperature) ^c	for 10 s			300	°C
Mounting torque	M3 screw			0.6	Nm

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature

b. V_{DD} = 50 V, starting T_J = 25 °C, L = 28.2 mH, R_g = 25 Ω , I_{AS} = 3.1 A

c. 1.6 mm from case

d. $I_{SD} \leq I_D, \, dI/dt$ = 100 A/µs, starting T_J = 25 $^\circ C$

e. Limited by maximum junction temperature



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THERMAL RESISTANCE RAT	INGS								
PARAMETER	SYMBOL	TYP.		MAX.	MAX.		UNIT		
Maximum junction-to-ambient	R _{thJA}	-		65					
Maximum junction-to-case (drain)	R _{thJC}	- 3.8			°C/W				
SPECIFICATIONS (T _J = 25 $^{\circ}$ C, u	unless otherwi	se noted)							
PARAMETER	SYMBOL	TES	T CONDIT	IONS	MIN.	TYP.	MAX.	UNIT	
Static						•			
Drain-source breakdown voltage	V _{DS}	V _{GS} =	= 0 V, I _D =	250 µA	500	-	-	V	
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$	Reference	e to 25 °C,	$I_D = 1 \text{ mA}$	-	0.62	-	V/°C	
Gate-source threshold voltage (N)	V _{GS(th)}	V _{DS} =	= V _{GS} , I _D =	250 µA	2.0	-	4.0	V	
			$V_{GS} = \pm 20$	V	-	-	± 100	nA	
Gate-source leakage	IGSS	,	V _{GS} = ± 30	V	-	-	± 1	μA	
Zero gata valtaga drain ourrant	1	V _{DS} =	= 500 V, V _G	_{iS} = 0 V	-	-	10		
Zero gate voltage drain current	IDSS	$V_{DS} = 300 \text{ V}, V_{GS} = 0 \text{ V}$ $V_{DS} = 400 \text{ V}, V_{GS} = 0 \text{ V}, T_J = 125 \text{ °C}$		-	-	25	μA		
Drain-source on-state resistance	R _{DS(on)}	$V_{GS} = 10 V$	l _i	_D = 7.5 A	-	0.243	0.280	Ω	
Forward transconductance	9 _{fs}	V _{DS} :	= 30 V, I _D =	= 7.5 A	-	3.9	-	S	
Dynamic						•		•	
Input capacitance	C _{iss}		V _{GS} = 0 V	1	-	1162	-		
Output capacitance	C _{oss}	$V_{GS} = 0.0$, $V_{DS} = 100$ V, f = 1 MHz		-	51	-	pF		
Reverse transfer capacitance	C _{rss}			-	7	-			
Effective output capacitance, energy related ^a	C _{o(er)}	V _{DS} = 0 V to 400 V, V _{GS} = 0 V		-	55	-			
Effective output capacitance, time related ^b	C _{o(tr)}	v _{DS} = 0 v	10 400 v,	v _{GS} = 0 v	-	164	-		
Total gate charge	Qg				-	33	66	1	
Gate-source charge	Q _{gs}	V _{GS} = 10 V I _D = 7.5 A, V _{DS} = 400 V		-	8	-	nC		
Gate-drain charge	Q _{gd}				-	14	-	1	
Turn-on delay time	t _{d(on)}				-	15	30		
Rise time	t _r	V _{DD} =	= 400 V, I _D	= 12 A	-	24	48	ns	
Turn-off delay time	t _{d(off)}	V _{GS} =	= 10 V, R _g :	= 9.1 Ω	-	34	68		
Fall time	t _f			-	18	36	1		
Gate input resistance	R _g	f = 1 MHz, open drain		-	0.85	-	Ω		
Drain-Source Body Diode Characteristi	cs								
Continuous source-drain diode current	١ _S	MOSFET symbol showing the integral reverse p - n junction diode		-	-	14.5	A		
Pulsed diode forward current	I _{SM}			-	-	28	~		
Diode forward voltage	V _{SD}	T _J = 25 °C	C, I _S = 7.5 /	A, V _{GS} = 0 V	-	-	1.2	V	
Reverse recovery time	t _{rr}				-	265	-	ns	
Reverse recovery charge	Q _{rr}	$T_{J} = 25$	5 °C, I _F = I _S 100 A/us	s = 7.5 A, Vp = 25 V	-	3.2	-	μC	
Reverse recovery current	I _{RRM}	$dl/dt = 100 \text{ A}/\mu \text{s}, \text{ V}_{\text{R}} = 25 \text{ V}$		-	23	-	Α		

Notes

a. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS} b. $C_{oss(tr)}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS}



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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

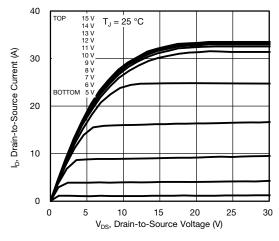


Fig. 1 - Typical Output Characteristics

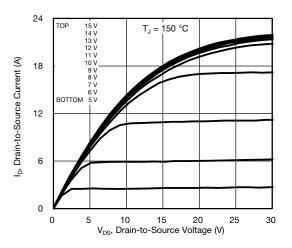


Fig. 2 - Typical Output Characteristics

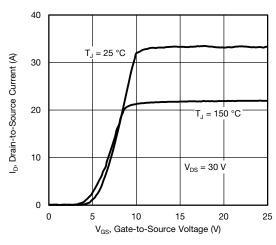


Fig. 3 - Typical Transfer Characteristics

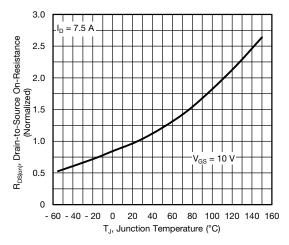


Fig. 4 - Normalized On-Resistance vs. Temperature

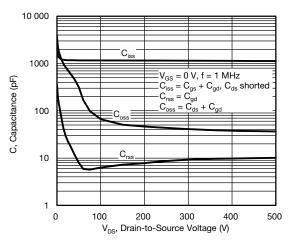


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

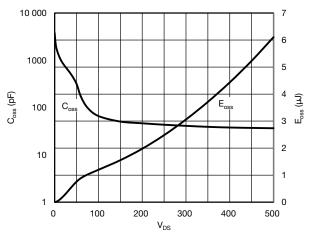


Fig. 6 - C_{oss} and E_{oss} vs. V_{DS}

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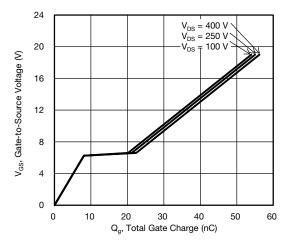


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

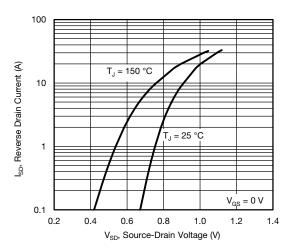
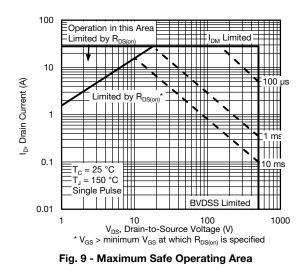


Fig. 8 - Typical Source-Drain Diode Forward Voltage



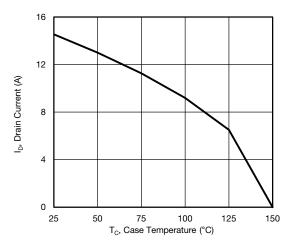


Fig. 10 - Maximum Drain Current vs. Case Temperature

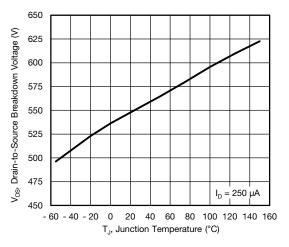
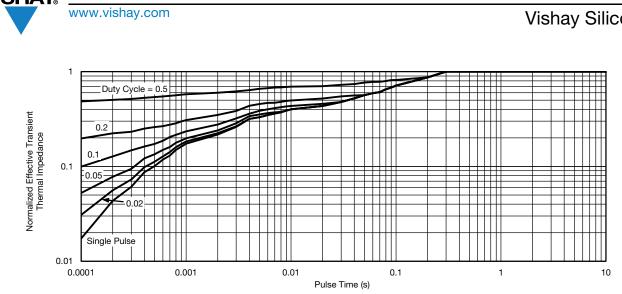


Fig. 11 - Temperature vs. Drain-to-Source Voltage

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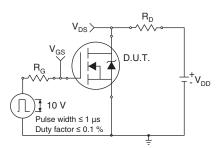


Fig. 13 - Switching Time Test Circuit

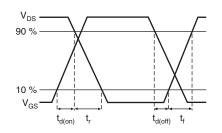


Fig. 14 - Switching Time Waveforms

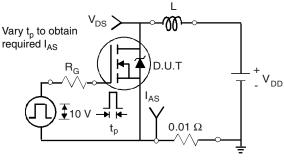


Fig. 15 - Unclamped Inductive Test Circuit

V_{DS} V_{DD} V_{DS} I_{AS}

Fig. 16 - Unclamped Inductive Waveforms

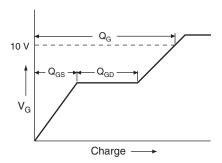


Fig. 17 - Basic Gate Charge Waveform

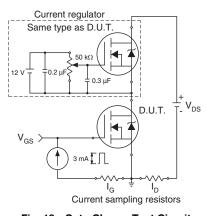


Fig. 18 - Gate Charge Test Circuit

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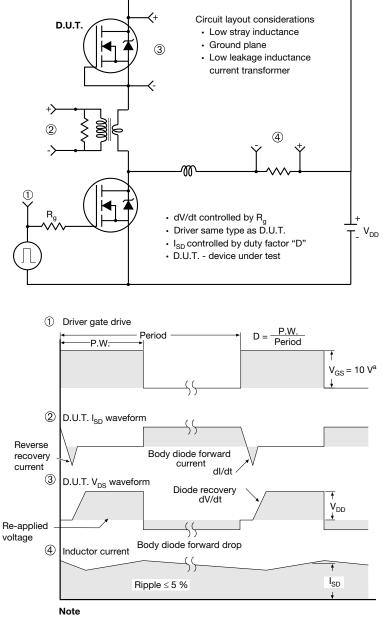
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SiHA15N50E

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Peak Diode Recovery dV/dt Test Circuit



a. $V_{GS} = 5 V$ for logic level devices

Fig. 19 - For N-Channel

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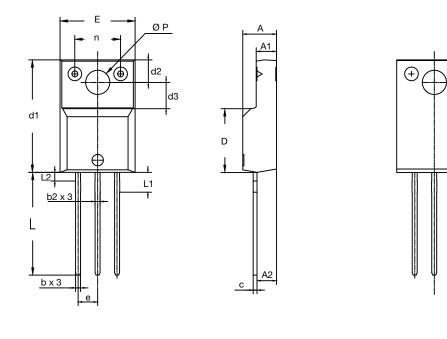
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TO-220 FULLPAK Thin Lead





	DIMENSIONS					
SYMBOL	MILLIN	IETERS	INC	HES		
	MIN.	MAX.	MIN.	MAX.		
А	4.30	4.70	0.169	0.185		
A1	2.50	2.90	0.098	0.114		
A2	2.50	2.70	0.098	0.106		
b	0.60	0.80	0.024	0.031		
b2	0.60	0.90	0.024	0.035		
С	-	0.60	-	0.024		
D	8.30	8.70	0.327	0.342		
d1	14.70	15.30	0.579	0.602		
d2	2.90	3.10	0.114	0.122		
d3	3.40	3.60	0.134	0.142		
E	9.70	10.30	0.382	0.406		
е	2.50	2.70	0.098	0.106		
L	13.40	13.80	0.528	0.543		
L1	2.50	2.80	0.098	0.110		
L2	-	1.20	-	0.047		
n	6.05	6.15	0.238	0.242		
ØP	3.00	3.40	0.118	0.134		

Revision: 12-Sep-16

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Document Number: 62649



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